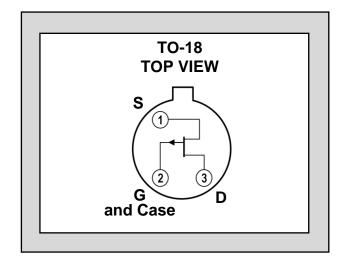


## Twenty-Five Years Of Quality Through Innovation

# **2N5018 SERIES**

# SINGLE P-CHANNEL JFET SWITCH

FEATURES						
DIRECT REPLACEMENT FOR SILICONIX 2N5018						
ZERO OFFSET VOLTAGE						
LOW ON RESISTANCE	LOW ON RESISTANCE 75Ω					
ABSOLUTE MAXIMUM RATINGS¹ @ 25 °C (unless otherwise stated)						
Maximum Temperatures	Maximum Temperatures					
Storage Temperature -55 to 150°C						
Junction Operating Temperature -55 to 150°C						
Maximum Power Dissipation						
Continuous Power Dissipation <sup>3</sup> 500mW						
Maximum Currents						
Gate Current -10mA						
Maximum Voltages						
Gate to Drain 30V						
Gate to Source 30V						



### STATIC ELECTRICAL CHARACERISTICS @25°C (unless otherwise stated)

· ·									
SYM.	CHARACTERISTIC	TYP	2N5018		2N5019		UNITS	CONDITIONS	
3 T IVI.			MIN	MAX	MIN	MAX	UNITS	CONDITIONS	
BV <sub>GSS</sub>	Gate to Source Breakdown Voltage		30		30			$I_G = 1\mu A$ , $V_{DS} = 0V$	
V <sub>GS(off)</sub>	Gate to Source Cutoff Voltage			10		5	٧	$V_{DS} = -15V, I_{D} = -1\mu A$	
V <sub>DS(on)</sub>	Drain to Source On Voltage			-0.5				$V_{GS} = 0V$ , $I_D = -6mA$	
						-0.5		$V_{GS} = 0V$ , $I_D = -3mA$	
IDSS	Drain to Source Saturation Current <sup>2</sup>		-10		-5		mA	$V_{DS} = -20V, V_{GS} = 0V$	
Igss	Gate Leakage Current			2		2	A	$V_{GS} = 15V$ , $V_{DS} = 0V$	
I <sub>D(off)</sub>	Drain Cutoff Current			-10		-10	nA	$V_{DS} = -15V$ , $V_{GS} = 12V$	
						-10	μΑ	$V_{DS} = -15V, V_{GS} = 7V$	
$I_{DGO}$	Drain Reverse Current			-2		-2	nA	$V_{DG} = -15V, I_{S} = 0A$	
r <sub>DS(on)</sub>	Drain to Source On Resistance			75		150	Ω	$I_D = -1 \text{mA}, V_{GS} = 0 \text{V}$	

#### DYNAMIC ELECTRICAL CHARACTERISTICS @25°C (unless otherwise stated)

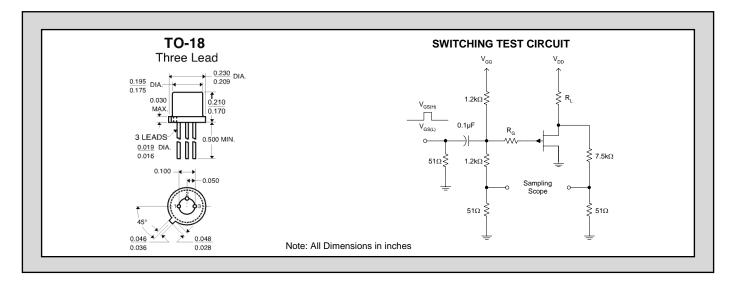
SYM.	CHARACTERISTIC	TYP	2N5018		2N5019		UNITS	CONDITIONS	
STIVI.	CHARACTERISTIC	111	MIN	MAX	MIN	MAX	UNITS	CONDITIONS	
r <sub>ds(on)</sub>	Drain to Source On Resistance			75		150	Ω	$I_D = -100 \mu A, V_{GS} = 0V$ f = 1 kHz	
C <sub>iss</sub>	Input Capacitance			45		45		$V_{DS} = -15V, V_{GS} = 0V$ f = 1MHz	
	Payaraa Transfer Canasitanaa			10			pF	$V_{DS} = 0V, V_{GS} = 12V$ f = 1MHz	
Crss	Reverse Transfer Capacitance					10		$V_{DS} = 0V$ , $V_{GS} = 7V$ f = 1MHz	

#### **SWITCHING CHARACTERISTICS (max)**

SYM.	CHARACTERISTIC	2N5018	2N5019	UNITS
t <sub>d(on)</sub>	Turn On Time	15	15	
tr	rum on Time	20	75	
t <sub>d(off)</sub>	Turn Off Time	15	25	ns
tf	rum On Time	50	100	

#### **SWITCHING CIRCUIT CHARACTERISTICS**

SYM.	2N5018	2N5019
$V_{DD}$	-6V	-6V
$V_{GG}$	12V	8V
$R_L$	910Ω	1.8ΚΩ
R <sub>G</sub>	220Ω	390Ω
$I_{D(on)}$	-6mA	-3mA
V <sub>GS(H)</sub>	0V	0V
$V_{GS(L)}$	12V	7V



#### **NOTES**

- 1. Absolute maximum ratings are limiting values above which serviceability may be impaired.
- 2. Pulse test: PW ≤ 300µs, Duty Cycle ≤ 3%
- 3. Derate 3mW/°C above 25°C.

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